

Product Summary

V _{(BR)DSS}	R _{DS(on)TYP}	l _D
40)/	8mΩ@10V	50A
40V	11mΩ@4.5V	50A
-40V	14mΩ@-10V	-24A
	18mΩ@-4.5V	-24A



Feature

- High power and current handing capability
- Lead free product is acquired
- Surface mount package
- 100% Single Pluse avalanche energy Test

Applications

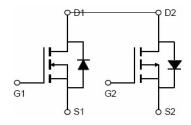
- Battery Protection
- Load Switch
- Power Management

Package

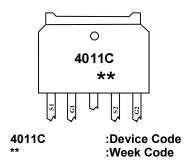


TO-252-4L

Circuit diagram



Marking



Order Information

Device	Package	Unit/Tape		
SP4011CTM	TO-252-4L	2500		



Absolute maximum ratings (Ta=25°C,unless otherwise noted)

Downston	Comple at	Value		11
Parameter	Symbol	N-Channel	P-Channel	Units
Drain-Source Voltage	V _{DS}	40	-40	V
Gate-Source Voltage	V _G s	±20	±20	V
Continuous Drain Current(T _C =25℃)	I _D	50	-24	Α
Continuous Drain Current(T _C =100°C)	I _D	33	-16	Α
Pulsed Drain Current	Ідм	200	-96	Α
Single Pulse Avalanche Energy ¹	E _{AS}	72	90	mJ
Power Dissipation(T _C =25°ℂ)	P _D	48		W
Thermal Resistance Junction-to-Case	Rejc	2.6		°C/W
Storage Temperature Range	T _{STG}	-55 to 150		$^{\circ}\!\mathbb{C}$
Operating Junction Temperature Range	TJ	-55 to 150		$^{\circ}\!\mathbb{C}$

N-Channel Electrical characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V , ID=250uA	40	_	_	V
Drain-Source Leakage Current	I _{DSS}	VDS=32V , VGS=0V , TJ=25℃	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	VGS=VDS , ID =250uA	1	1.5	2.5	V
0 0 . 0		VGS=10V , ID=7A	-	8	12	m0
Static Drain-Source On-Resistance	R _{DS(ON)}	VGS=4.5V , ID=6A	-	11	18	mΩ
Dynamic characteristics	-				1	
Input Capacitance	C _{iss}		-	1434	-	
Output Capacitance	Coss	VDS=15V , VGS=0V , f=1MHz	-	91	-	pF
Reverse Transfer Capacitance	C _{rss}		-	75	-	1
Total Gate Charge	Qg		-	25	-	
Gate-Source Charge	Q _{gs}	VDS=32V , VGS=4.5V , ID=7A	-	6.3	-	nC
Gate-Drain Charge	Q_{gd}			4.6	-	1
Switching Characteristics	'				'	
Turn-On Delay Time	T _{d(on)}		-	7.8	-	
Rise Time	Tr	VDD=20V, VGS=10V , RG=3Ω, ID=7A	-	10.7	-	nS
Turn-Off Delay Time	T _{d(off)}		-	25.8	-	113
Fall Time	T _f			4.6	-	1
Diode Characteristics						
Diode Forward Voltage	V _{SD}	VGS=0V , IS=1A , TJ=25℃	-	-	1.2	V
Maximum Body-Diode Continuous Current	Is		-	-	50	Α
Reverse Recovery Time	T _{rr}	L=204 di/dt=1004/up TI=25°C	-	12.5	-	nS
Reverse Recovery Charge	Q _{rr}	− I _s =20A, di/dt=100A/us, TJ=25℃		9	-	nC

Note

^{1.}The EAS test condition is VDD=20V,VGS=10V,L=0.5mH,RG=25 Ω



P-Channel Electrical characteristics (Ta=25℃, unless otherwise noted)

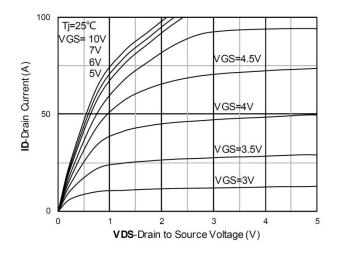
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V , ID=-250uA	-40	-	_	V	
Drain-Source Leakage Current	I _{DSS}	VDS=-32V , VGS=0V , TJ=25℃	-	-	-1	uA	
Gate-Source Leakage Current	I _{GSS}	VGS=±20V, VDS=0V	-	-	±100	nA	
Gate Threshold Voltage	V _{GS(th)}	VGS=VDS , ID =-250uA	-1	-1.5	-2.5	V	
		VGS=-10V , ID=-5A	_	14	18		
Static Drain-Source On-Resistance	R _{DS(ON)}	VGS=-4.5V , ID=-4A	-	18	24	mΩ	
Dynamic characteristics							
Input Capacitance	C _{iss}		-	1415	-		
Output Capacitance	Coss	VDS=-15V , VGS=0V , f=1MHz	-	204	-	pF	
Reverse Transfer Capacitance	C _{rss}	1		112	-		
Total Gate Charge	Qg			23.5	-		
Gate-Source Charge	Q _{gs}	VDS=-15V , VGS=-4.5V , ID=-1A	-	3.4	-	nC	
Gate-Drain Charge	Q_{gd}			4.3	-	1	
Switching Characteristics	•						
Turn-On Delay Time	T _{d(on)}			11	-		
Rise Time	Tr	VDD 45V VOC 40V DC 20 ID 44	-	16.7	-	nS	
Turn-Off Delay Time	T _{d(off)}	- VDD=-15V, VGS=-10V , RG=3Ω, ID=-1A		35	-	113	
Fall Time	T _f			19	-		
Diode Characteristics							
Diode Forward Voltage	V _{SD}	VGS=0V , IS=-1A , TJ=25℃	-	-	-1.2	V	
Maximum Body-Diode Continuous Current	Is		-	-	-24	Α	
Reverse Recovery Time	T _{rr}	I _S =-15A, di/dt=100A/us, TJ=25℃		28	-	nS	
Reverse Recovery Charge	Qrr			36	-	nC	

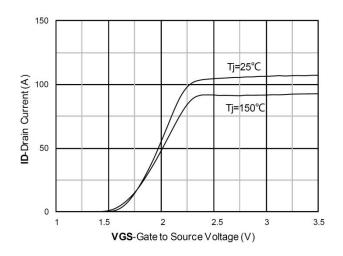
Note:

^{1.}The EAS test condition is VDD=-20V,VGS=-10V,L=0.5mH,RG=25 Ω

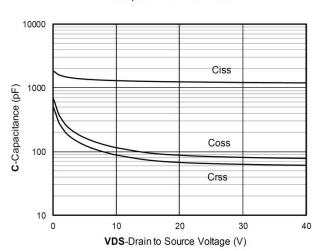


N-Channel Typical Characteristics

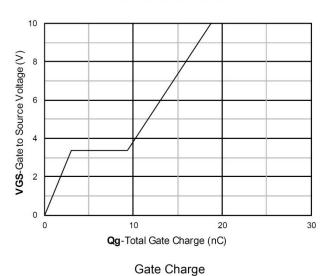




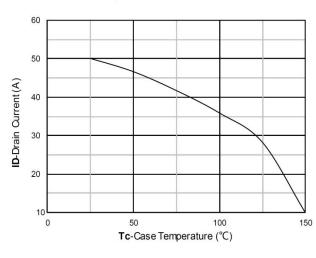
Output Characteristics



Transfer Characteristics



Capacitance Characteristics



Current dissipation

Power dissipation

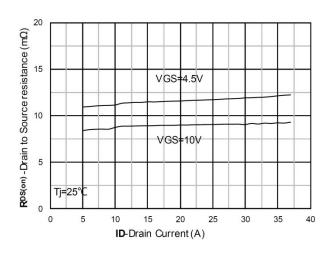
Tc-Case Temperature (°C)

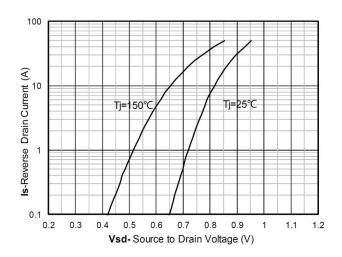
50

0

0

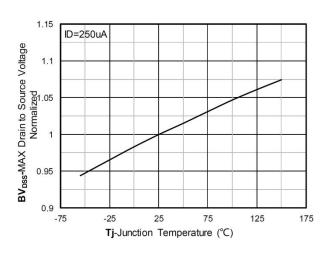


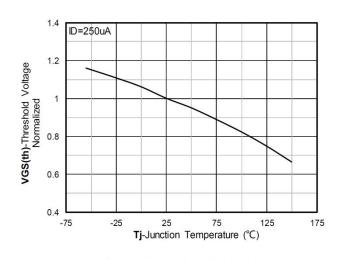




RDS(on) VS Drain Current

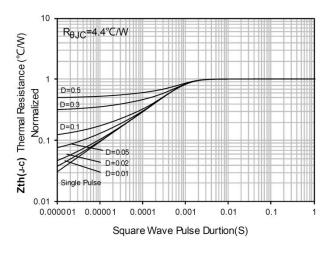
Forward characteristics of reverse diode

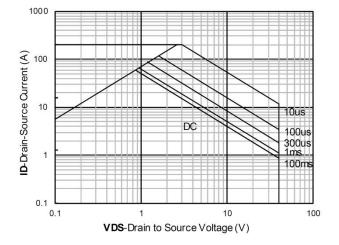




Normalized breakdown voltage

Normalized Threshold voltage



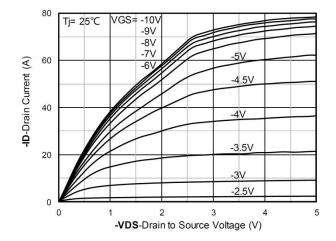


Maximum Transient Thermal Impedance

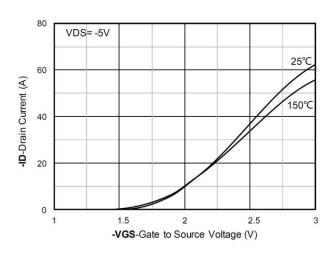
Safe Operation Area



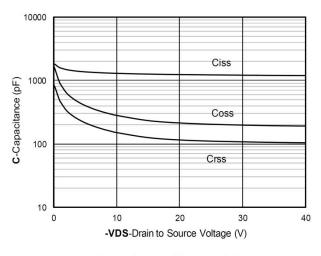
P-Channel Typical Characteristics



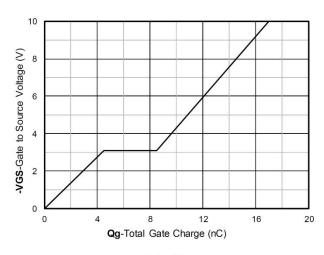
Output Characteristics



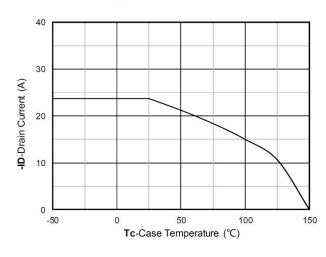
Transfer Characteristics



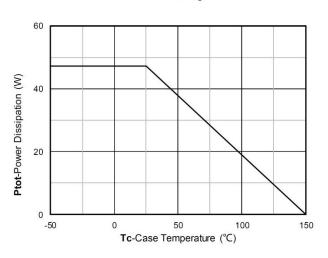
Capacitance Characteristics



Gate Charge

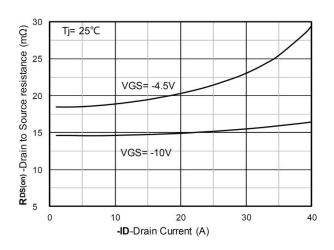


Current dissipation



Power dissipation

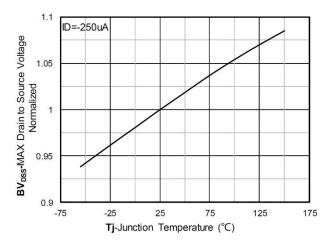


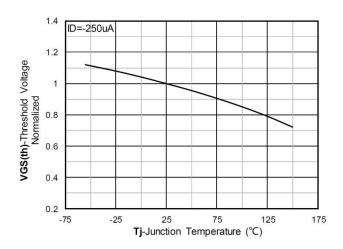


100 (Y) 10 150°C 25°C 1150°C 25°C 1150°C 25°C 1150°C 115

RDS(on) VS Drain Current

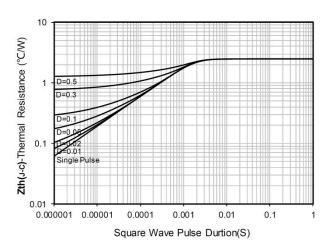
Forward characteristics of reverse diode

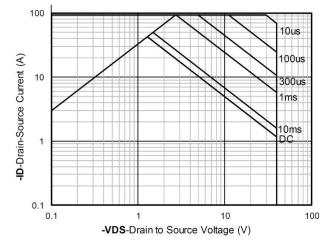




Normalized breakdown voltage

Normalized Threshold voltage



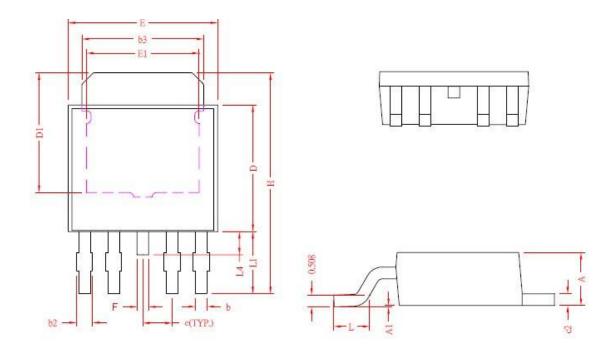


Maximum Transient Thermal Impedance

Safe Operation Area



TO-252-4L Package Information



Symbol	Dimensions In Millimeters			
	Min.	Max.		
А	2.20	2.40		
A1	0	0.15		
b	0.40	0.60		
b2	0.50	0.80		
b3	5.20	5.50		
c2	0.45	0.55		
D	5.40	5.80		
D1	4.57	-		
E	6.40	6.80		
E1	3.81	-		
е	1.27REF.			
F	0.40	0.60		
Н	9.40	10.20		
L	1.40 1.77			
L1	2.40	3.00		
L4	0.80	1.20		